



# STHDLS101T

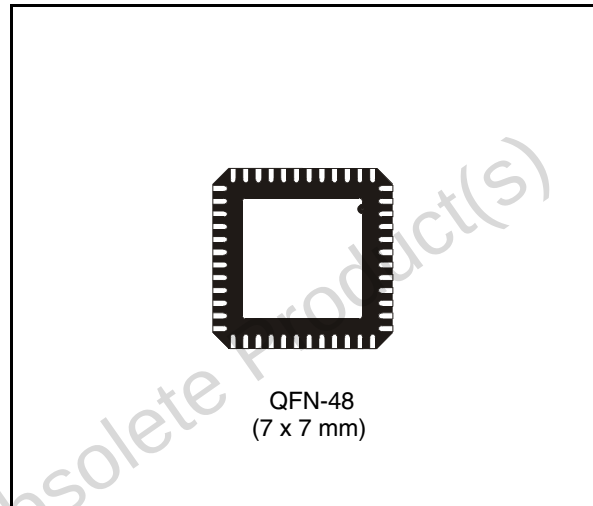
AC coupled HDMI level shifter  
with configurable HPD output

## Features

- Converts low-swing alternating current (AC) coupled differential input to high-definition multimedia interface (HDMI) rev 1.3 compliant
- HDMI level shifting operation up to 2.7 Gbps per lane
- Integrated 50- $\Omega$  termination resistors for AC-coupled differential inputs
- Input/output transition minimized differential signaling (TMDS) enable/disable
- Output slew rate control on TMDS outputs to minimize electromagnetic interference (EMI)
- Fail safe outputs for backdrive protection
- No re-timing or configuration required
- Inter-pair output skew < 250 ps
- Intra-pair output skew < 10 ps
- Single power supply of 3.3 V
- ESD protection:  $\pm 6$  KV HBM on all I/O pins
- Integrated display data channel (DDC) level shifters. Pass-gate voltage limiters allow 3.3 V termination on graphics and memory controller hub (GMCH) pins and 5 V DDC termination on HDMI connector pins
- Level shifter and configurable output for HPD signal from HDMI/DVI connector
- Integrated pull-down resistor on HPD\_SINK and OE\_N inputs

## Applications

- Notebooks
- PC motherboards and graphic cards
- Dongles/cable adapters



## Description

The STHDLS101T is a high-speed high-definition multimedia interface (HDMI) level shifter that converts low-swing AC coupled differential input to HDMI 1.3 compliant open-drain current steering RX-terminated differential output. Through the existing PCI-E pins in the graphics and memory controller hub (GMCH) of PCs or notebook motherboards, the pixel clock provides the required bandwidth (1.65 Gbps, 2.25 Gbps) for the video supporting 720p, 1080i, 1080p with a total of 36-bit resolution. The HDMI is multiplexed onto the PCIe pins in the motherboard where the AC coupled HDMI at 1.2 V is output by GMCH. The AC coupled HDMI is then level shifter by this device to 3.3 V DC coupled HDMI output.

The STHDLS101T supports up to 2.7 Gbps, which is enough for 12-bits of color depth per channel, as indicated in HDMI rev 1.3. The device operates from a single 3.3 V supply and is available in a 48-pin QFN package.

Table 1. Device summary

| Order code    | Package | Packaging     |
|---------------|---------|---------------|
| STHDLS101TQTR | QFN-48  | Tape and reel |

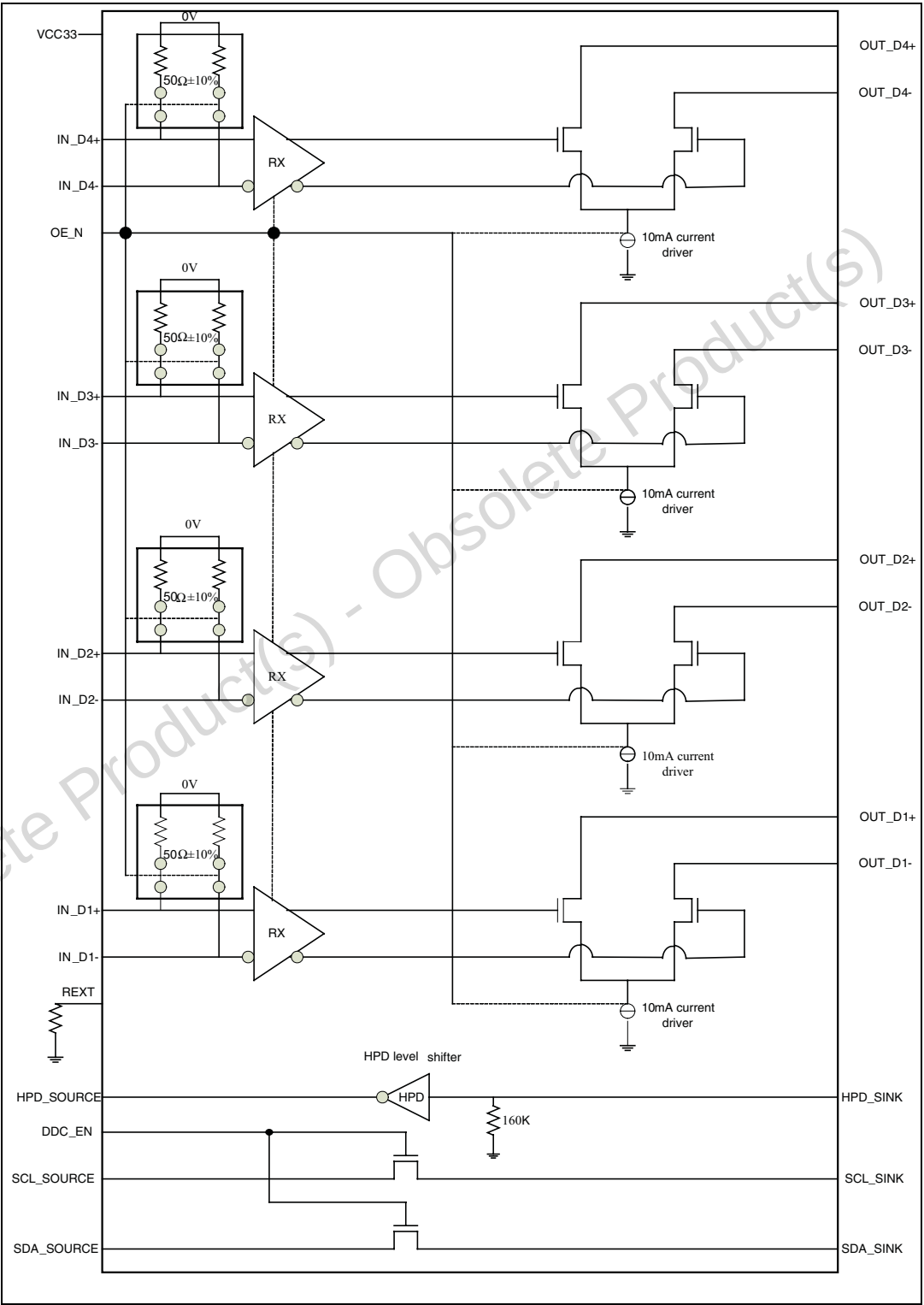
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Obsolete Product(s) - Obsolete Product(s)

# 1 Block diagram

Figure 1. STHDLS101T block diagram



## 2 System interface

Figure 2. System interface

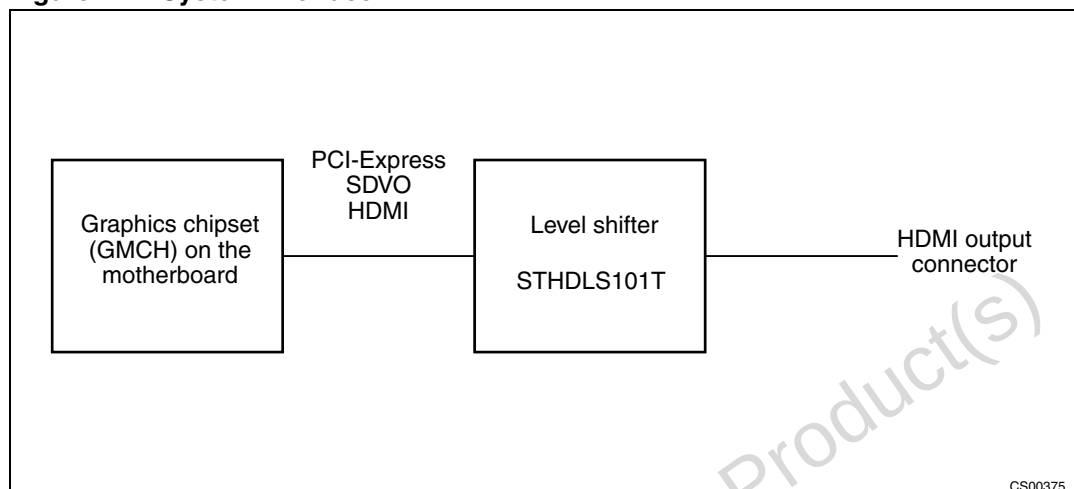
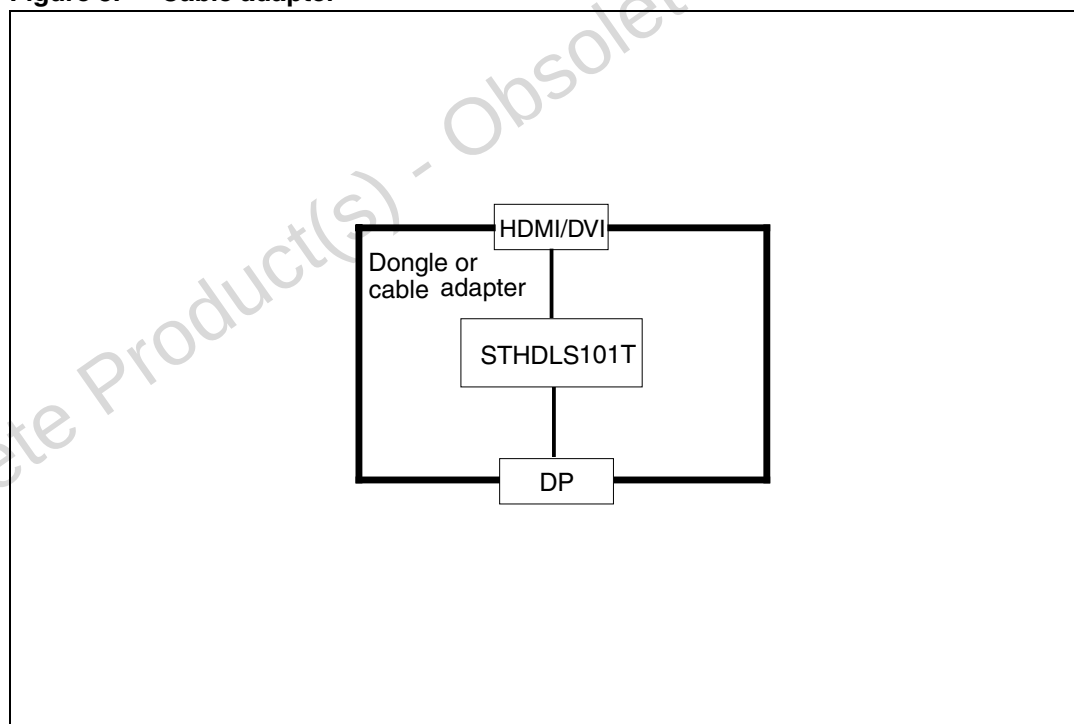
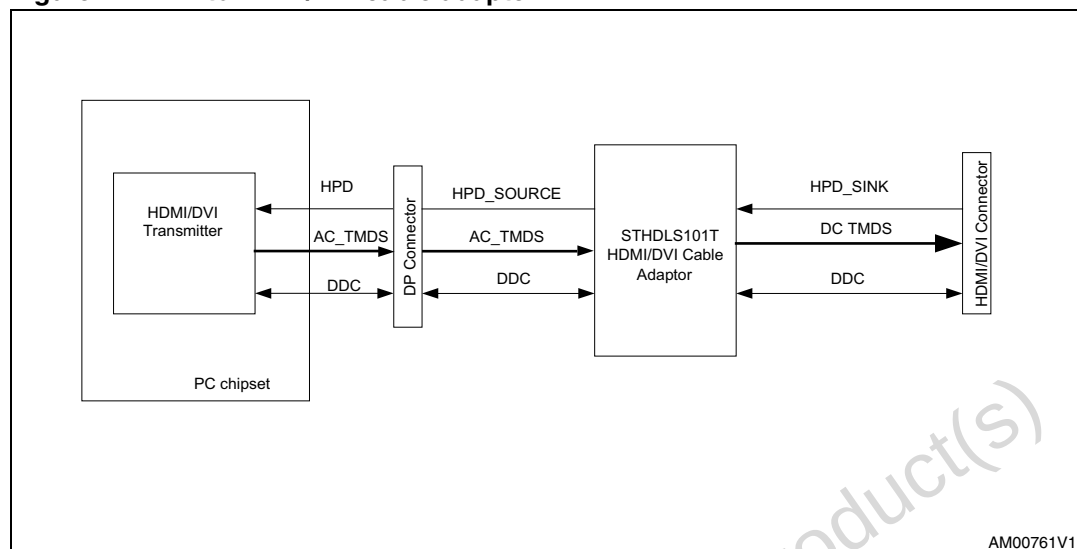


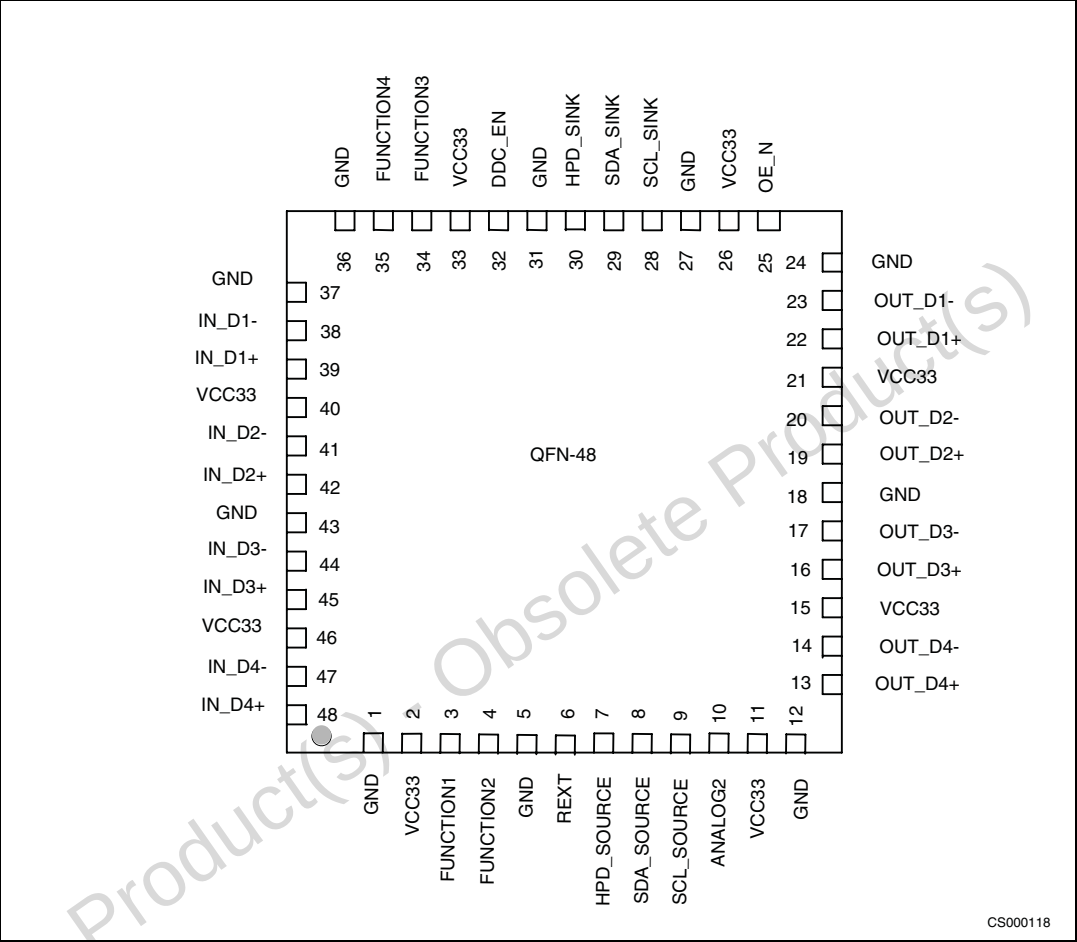
Figure 3. Cable adapter



**Figure 4. DP to HDMI/DVI cable adapter**

3 Pin configuration

Figure 5. STHDLS101T pin configuration



### 3.1 Pin description

**Table 2. Pin description**

| Pin number | Name       | Type                                 | Function                                                                                                                                                                                                                                                                            |            |                                                                                |
|------------|------------|--------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|--------------------------------------------------------------------------------|
| 1          | GND        | Power                                | Ground                                                                                                                                                                                                                                                                              |            |                                                                                |
| 2          | VCC33      | Power                                | 3.3V±10% DC supply                                                                                                                                                                                                                                                                  |            |                                                                                |
| 3          | FUNCTION1  | Vendor-specific control or test pins | Function pins are to enable vendor-specific features or test modes.<br>For normal operation, these pins are tied to GND or VCC33.<br>For consistent interoperability, GND is the preferred default connection for these signals                                                     |            |                                                                                |
| 4          | FUNCTION2  | Vendor-specific control or test pins | Function pins are to enable vendor-specific features or test modes.<br>For normal operation, these pins are tied to GND or VCC33.<br>For consistent interoperability, GND is the preferred default connection for these signals                                                     |            |                                                                                |
| 5          | GND        | Power                                | Ground                                                                                                                                                                                                                                                                              |            |                                                                                |
| 6          | REXT       | Analog                               | Connection to external resistor. Resistor value specified by device manufacturer.<br>Acceptable connections to this pin are:<br>- Resistor to GND<br>- Resistor to 3.3V;<br>- NC (direct connections to V <sub>CC</sub> or GND are through a 0-Ω resistor for layout compatibility) |            |                                                                                |
| 7          | HPD_SOURCE | Output                               | Buffer from the 0 V to 5 V input signal. The output buffer stage is configurable based on the FUNCTION3 pin settings as described in the table below:                                                                                                                               |            |                                                                                |
|            |            |                                      | FUNCTION3                                                                                                                                                                                                                                                                           | HPD_SINK   | HPD_SOURCE                                                                     |
|            |            |                                      | 0                                                                                                                                                                                                                                                                                   | Low        | Open-drain, connected an external pull up to the desired supply (normally 1 V) |
|            |            |                                      | 0                                                                                                                                                                                                                                                                                   | High (5 V) | Low (0 V)                                                                      |
|            |            |                                      | 1                                                                                                                                                                                                                                                                                   | Low (0 V)  | Low (0 V)                                                                      |
|            |            |                                      | 1                                                                                                                                                                                                                                                                                   | High (5 V) | High (3 V)                                                                     |
| 8          | SDA_SOURCE | I/O                                  | 3.3 V DDC data I/O. Pulled-up by external termination to 3.3 V. Connected to SDA_SINK through voltage-limiting integrated NMOS pass-gate                                                                                                                                            |            |                                                                                |
| 9          | SCL_SOURCE | Input                                | 3.3 V DDC clock I/O. Pulled-up by external termination to 3.3 V. Connected to SCL_SINK through voltage-limiting integrated NMOS pass-gate                                                                                                                                           |            |                                                                                |

Table 2. Pin description (continued)

| Pin number | Name    | Type   | Function                                                                                                                                                                                       |                  |               |
|------------|---------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|---------------|
| 10         | ANALOG2 | Analog | Analog connection determined by vendor.<br>Acceptable connections to this pin are:<br>- Resistor or capacitor to GND<br>- Resistor or capacitor to 3.3 V<br>- Short to 3.3 V or to GND<br>- NC |                  |               |
| 11         | VCC33   | Power  | 3.3 V ±10% DC supply                                                                                                                                                                           |                  |               |
| 12         | GND     | Power  | Ground                                                                                                                                                                                         |                  |               |
| 13         | OUT_D4+ | Output | HDMI 1.3 compliant TMDS output.<br>OUT_D4+ makes a differential output signal with OUT_D4-.                                                                                                    |                  |               |
| 14         | OUT_D4- | Output | HDMI 1.3 compliant TMDS output.<br>OUT_D4- makes a differential output signal with OUT_D4+.                                                                                                    |                  |               |
| 15         | VCC33   | Power  | 3.3 V±10% DC supply                                                                                                                                                                            |                  |               |
| 16         | OUT_D3+ | Output | HDMI 1.3 compliant TMDS output.<br>OUT_D3+ makes a differential output signal with OUT_D3-.                                                                                                    |                  |               |
| 17         | OUT_D3- | Output | HDMI 1.3 compliant TMDS output.<br>OUT_D3- makes a differential output signal with OUT_D3+.                                                                                                    |                  |               |
| 18         | GND     | Power  | Ground                                                                                                                                                                                         |                  |               |
| 19         | OUT_D2+ | Output | HDMI 1.3 compliant TMDS output.<br>OUT_D2+ makes a differential output signal with OUT_D2-.                                                                                                    |                  |               |
| 20         | OUT_D2- | Output | HDMI 1.3 compliant TMDS output.<br>OUT_D2- makes a differential output signal with OUT_D2+.                                                                                                    |                  |               |
| 21         | VCC33   | Power  | 3.3 V±10% DC supply                                                                                                                                                                            |                  |               |
| 22         | OUT_D1+ | Output | HDMI 1.3 compliant TMDS output. OUT_D1+ makes a differential output signal with OUT_D1-.                                                                                                       |                  |               |
| 23         | OUT_D1- | Output | HDMI 1.3 compliant TMDS output. OUT_D1- makes a differential output signal with OUT_D1+.                                                                                                       |                  |               |
| 24         | GND     | Power  | Ground                                                                                                                                                                                         |                  |               |
| 25         | OE_N    | Input  | Enable for level shifter path. 3.3 V tolerant low-voltage single-ended input. Internal pull-down enables chip when unconnected.                                                                |                  |               |
|            |         |        | OE_N                                                                                                                                                                                           | IN_D termination | OUT_D Outputs |
|            |         |        | 1                                                                                                                                                                                              | High-Z           | High-Z        |
|            |         |        | 0                                                                                                                                                                                              | 50 Ω             | Active        |
| 26         | VCC33   | Power  | 3.3 V±10% DC supply                                                                                                                                                                            |                  |               |

Table 2. Pin description (continued)

| Pin number | Name      | Type                                 | Function                                                                                                                                                                                                                                               |
|------------|-----------|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 27         | GND       | Power                                | Ground                                                                                                                                                                                                                                                 |
| 28         | SCL_SINK  | Output                               | 5 V DDC Clock I/O. Pulled-up by external termination to 5 V. Connected to SCL_SOURCE through voltage-limiting integrated NMOS pass-gate                                                                                                                |
| 29         | SDA_SINK  | I/O                                  | 5V DDC Data I/O. Pulled-up by external termination to 5V. Connected to SDA_SOURCE through voltage-limiting integrated NMOS pass-gate                                                                                                                   |
| 30         | HPD_SINK  | Input                                | Low-frequency, 0V to 5V (nominal) input signal. This signal comes from the HDMI connector. Voltage high indicates “plugged” state; voltage low indicates “unplugged” state. HPD_SINK is pulled down by an integrated 160K $\Omega$ pull-down resistor. |
| 31         | GND       | Power                                | Ground                                                                                                                                                                                                                                                 |
| 32         | DDC_EN    | Input                                | Enables bias voltage to the DDC pass-gate level shifter gates. (May be implemented as a bias voltage connection to the DDC pass-gate themselves).                                                                                                      |
|            |           |                                      | <b>DDC_EN</b> <b>Pass-gate</b>                                                                                                                                                                                                                         |
|            |           |                                      | 0 V Disabled                                                                                                                                                                                                                                           |
|            |           |                                      | 3.3 V Enabled                                                                                                                                                                                                                                          |
| 33         | VCC33     | Power                                | 3.3V $\pm$ 10% DC supply                                                                                                                                                                                                                               |
| 34         | FUNCTION3 | Input                                | Used for polarity control of the HPD_SOURCE output. When L, the HPD_SOURCE is an open-drain output and when H, the HPD_SOURCE is a buffered output (0 V to V <sub>CC</sub> )                                                                           |
| 35         | FUNCTION4 | Vendor-specific control or test pins | Function pins are to enable vendor-specific features or test modes.<br>For normal operation, these pins are tied to GND or VCC33.<br>For consistent interoperability, GND is the preferred default connection for these signals                        |
| 36         | GND       | Power                                | Ground                                                                                                                                                                                                                                                 |
| 37         | GND       | Power                                | Ground                                                                                                                                                                                                                                                 |
| 38         | IN_D1-    | Input                                | Low-swing differential input from GMCH PCIE outputs. IN_D1- makes a differential pair with IN_D1+.                                                                                                                                                     |
| 39         | IN_D1+    | Input                                | Low-swing differential input from GMCH PCIE outputs. IN_D1+ makes a differential pair with IN_D1-.                                                                                                                                                     |
| 40         | VCC33     | Power                                | 3.3 V $\pm$ 10% DC supply                                                                                                                                                                                                                              |
| 41         | IN_D2-    | Input                                | Low-swing differential input from GMCH PCIE outputs. IN_D2- makes a differential pair with IN_D2+.                                                                                                                                                     |
| 42         | IN_D2+    | Input                                | Low-swing differential input from GMCH PCIE outputs. IN_D2+ makes a differential pair with IN_D2-.                                                                                                                                                     |

Table 2. Pin description (continued)

| Pin number | Name   | Type  | Function                                                                                           |
|------------|--------|-------|----------------------------------------------------------------------------------------------------|
| 43         | GND    | Power | Ground                                                                                             |
| 44         | IN_D3- | Input | Low-swing differential input from GMCH PCIE outputs. IN_D3- makes a differential pair with IN_D3+. |
| 45         | IN_D3+ | Input | Low-swing differential input from GMCH PCIE outputs. IN_D3+ makes a differential pair with IN_D3-. |
| 46         | VCC33  | Power | 3.3 V±10% DC supply                                                                                |
| 47         | IN_D4- | Input | Low-swing differential input from GMCH PCIE outputs. IN_D4- makes a differential pair with IN_D4+. |
| 48         | IN_D4+ | Input | Low-swing differential input from GMCH PCIE outputs. IN_D4+ makes a differential pair with IN_D4-. |

## 4 Functional description

The section describes the basic functionality of the STHDLS101T device.

### Power supply

The STHDLS101T is powered by a single DC power supply of  $3.3\text{ V} \pm 10\%$ .

### Clocking

This device does not retime any data. The device contains no state machines. No inputs or outputs of the device are latched or clocked.

### Reset

This device acts as a level shifter, reset is not required.

### OE\_N function

When OE\_N is asserted (low level), the IN\_D and OUT\_D signals are fully functional. Input termination resistors are enabled and any internal bias circuits are turned on.

OE\_N pin has an internal pull-down that enables the chip if left unconnected.

When OE\_N is de-asserted (high level), the OUT\_D outputs are in high impedance state. The IN\_D input buffers are disabled and the IN\_D termination resistors are disabled. Internal bias circuits for the differential inputs and outputs are turned off. Power consumption of the chip is minimized.

The HPD\_SINK input and HPD\_SOURCE output are not affected by OE\_N. The SCL and SDA pass-gates are not affected by OE\_N.

**Table 3. OE\_N description**

| OE_N                                   | Device state                                                                                                                                                                                                                                                                                                 | Comments                                                                                                                                                                                                                                                                                                                                                       |
|----------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Asserted (low level)<br>or unconnected | Differential input buffers and output buffers enabled. Input impedance = $50\Omega$                                                                                                                                                                                                                          | Normal functioning state for IN_D to OUT_D level shifting function.                                                                                                                                                                                                                                                                                            |
| De-asserted (high level)               | <p>Low-power state.</p> <p>Differential input buffers and terminations are disabled. Differential input buffers are in high-impedance state.</p> <p>OUT_D level shifting outputs are disabled. OUT_D level shifting outputs are in a high-impedance state.</p> <p>Internal bias currents are turned off.</p> | <p>Intended for lowest power condition when:</p> <ul style="list-style-type: none"> <li>• No display is plugged in or</li> <li>• The level shifted data path is disabled</li> </ul> <p>HPD_SINK input and HPD_SOURCE output are not affected by OE_N.</p> <p>SCL_SOURCE, SCL_SINK, SDA_SOURCE and SDA_SINK signals and functions are not affected by OE_N.</p> |

Table 4. OE\_N function

| OE_N                                      | IN_Dx                   | OUT_Dx<br>(TMDS outputs) | Notes                                                                        |
|-------------------------------------------|-------------------------|--------------------------|------------------------------------------------------------------------------|
| De-asserted<br>(high level)               | High-Z                  | High-Z                   | Device disabled.<br>Low power state.<br>Internal bias currents are disabled. |
| Asserted or<br>unconnected<br>(low level) | 50 $\Omega$ termination | Enabled                  | Level shifting mode<br>enabled.                                              |

## 5 Maximum ratings

Stressing the device above the rating listed in the “Absolute maximum ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

**Table 5. Absolute maximum ratings**

| Symbol    | Parameter                                             |                  | Value        | Unit |
|-----------|-------------------------------------------------------|------------------|--------------|------|
| $V_{CC}$  | Supply voltage to ground potential                    |                  | -0.5 to +4.0 | V    |
| $V_I$     | DC input voltage (TMDS and PCIe ports)                |                  | -0.5 to +4.0 | V    |
|           | Control pins                                          |                  | -0.5 to +4.0 | V    |
|           | SDA_SINK, SCL_SINK, HPD_SINK pins                     |                  | -0.5 to +6   | V    |
| $I_O$     | DC output current                                     |                  | 120          | mA   |
| $P_D$     | Power dissipation                                     |                  | 1            | W    |
| $T_{STG}$ | Storage temperature                                   |                  | -65 to +150  | °C   |
| $T_L$     | Lead temperature (10 sec)                             |                  | 300          | °C   |
| $V_{ESD}$ | Electrostatic discharge voltage on IOs <sup>(1)</sup> | Human body model | ±6           | kV   |

1. In accordance with the MIL standard 883 method 3015

**Table 6. Thermal data**

| Symbol        | Parameter                            | QFN-48 | Unit |
|---------------|--------------------------------------|--------|------|
| $\theta_{JA}$ | Junction-ambient thermal coefficient | 48     | °C/W |

## 5.1 Recommended operating conditions

### 5.1.1 Power supply and temperature range

Table 7. Power supply and temperature range

| Symbol     | Parameter                    | Comments                                          | Min | Typ | Max | Unit |
|------------|------------------------------|---------------------------------------------------|-----|-----|-----|------|
| $V_{CC33}$ | 3.3 V power supply           |                                                   | 3.0 | 3.3 | 3.6 | V    |
| $I_{CC}$   | Maximum power supply current | Total current from $V_{CC}$<br>3.3 V power supply |     |     | 100 | mA   |
| T          | Operating temperature range  |                                                   | -40 |     | 85  | °C   |

### 5.1.2 Differential inputs (IN\_D signals)

Table 8. Differential input characteristics for IN\_D signals

| Symbol           | Parameter                                                               | Comments                                                                                                                                                                        | Min   | Typ | Max | Unit       |
|------------------|-------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-----|-----|------------|
| Tbit             | Unit interval                                                           | Tbit is determined by the display mode. Nominal bit rate ranges from 250 Mbps to 2.5 Gbps per lane. Nominal Tbit at 2.5 Gbps = 400 ps. 360 ps = 400 ps – 10%                    | 360   |     |     | ps         |
| $V_{RX-DIFFp-p}$ | Differential input peak to peak voltage                                 | $V_{RX-DIFFp-p} = 2 \cdot  V_{RX-D+} - V_{RX-D-} $ . Applies to IN_D signals.                                                                                                   | 0.175 |     | 1.2 | V          |
| $T_{RX-EYE}$     | Minimum eye width at IN_D input pair                                    | The level shifter may add a maximum of 0.02UI jitter                                                                                                                            | 0.8   |     |     | Tbit       |
| $V_{CM-AC-pp}$   | AC peak common mode input voltage                                       | $V_{CM-AC-pp} =  V_{RX-D+} + V_{RX-D-} /2 - V_{RX-CM-DC}$ .<br>$V_{RX-CM-DC} = DC(avg)$ of $ V_{RX-D+} + V_{RX-D-} /2$<br>$V_{CM-AC-pp}$ includes all frequencies above 30 kHz. |       |     | 100 | mV         |
| $Z_{RX-DC}$      | DC single-ended input impedance                                         | Applies to IN_D+ as well as IN_D- pins (50 $\Omega$ $\pm$ 20% tolerance)                                                                                                        | 40    | 50  | 60  | $\Omega$   |
| $V_{RX-Bias}$    | RX input termination voltage                                            | Intended to limit power-up stress on chipset's PCIE output buffers                                                                                                              | 0     |     | 2   | V          |
| $Z_{RX-HIGH-Z}$  | Single-ended input resistance for IN_Dx when inputs are in high-Z state | Differential inputs must be in a high impedance state                                                                                                                           | 100   |     |     | K $\Omega$ |

## 5.2 TMDS outputs (OUT\_D signals)

The level shifter's TMDS outputs are required to meet the HDMI 1.3 specifications. The HDMI 1.3 specification is assumed to be the correct reference in instances where this document conflicts with the HDMI 1.3 specification.

**Table 9. Differential output characteristics for TMDS OUT\_D signals**

| Symbol           | Parameter                              | Comments                                                                                                | Min                     | Typ                     | Max                     | Unit          |
|------------------|----------------------------------------|---------------------------------------------------------------------------------------------------------|-------------------------|-------------------------|-------------------------|---------------|
| $V_H$            | Single-ended high level output voltage | $AV_{CC}$ is the DC termination voltage in the HDMI or DVI sink. $AV_{CC}$ is nominally 3.3 V           | $AV_{CC}-10\text{ mV}$  | $AV_{CC}$               | $AV_{CC}+10\text{ mV}$  | V             |
| $V_L$            | Single-ended low level output voltage  | The open-drain output pulls down from $AV_{CC}$                                                         | $AV_{CC}-600\text{ mV}$ | $AV_{CC}-500\text{ mV}$ | $AV_{CC}-400\text{ mV}$ | V             |
| $V_{SWING}$      | Single-ended output swing voltage      | Swing down from TMDS termination voltage (3.3 V $\pm 10\%$ )                                            | 400 mV                  | 500 mV                  | 600 mV                  | V             |
| $I_{OFF}$        | Single-ended current in high-Z state   | Measured with TMDS outputs pulled up to $AV_{CC}$ max (3.6 V) through 50 $\Omega$ resistors             |                         |                         | 10                      | $\mu\text{A}$ |
| $T_R$            | Rise time                              | Maximum rise/fall time at 2.7 Gbps = 148ps. 125ps = 148 – 15%                                           | 125 ps                  |                         | 0.4 Tbit                | ps            |
| $T_F$            | Fall time                              | Maximum rise/fall time at 2.7 Gbps = 148 ps. 125ps = 148 – 15%                                          | 125 ps                  |                         | 0.4 Tbit                | ps            |
| $T_{SKEW-INTR}$  | Intra-pair differential skew           | This differential skew budget is in addition to the skew presented between D+ and D- paired input pins. |                         |                         | 10                      | ps            |
| $T_{SKEW-INTER}$ | Inter-pair lane to lane output skew    | This lane to lane skew budget is in addition to the skew between differential input pairs.              |                         |                         | 250                     | ps            |
| $T_{JIT}$        | Jitter added to TMDS signals           | Jitter budget for TMDS signals as they pass through the level shifter. 7.4 ps = 0.02 Tbit at 2.7 Gbps   |                         |                         | 7.4                     | ps            |

### 5.3 HPD input and output characteristics

Table 10. HPD\_SINK input and HPS\_SOURCE output

| Symbol                     | Parameter                                       | Comment                                                                                                                                             | Min | Typ | Max      | Unit    |
|----------------------------|-------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|----------|---------|
| $V_{IH-HPD\_SINK}$         | HPD_SINK input high level                       | Low speed input changes state on cable plug/unplug                                                                                                  | 2   | 5.0 | 5.3      | V       |
| $V_{IL-HPD\_SINK}$         | HPD_SINK input low level                        |                                                                                                                                                     | 0   |     | 0.8      | V       |
| $I_{IN-HPD\_SINK}$         | HPD_SINK input leakage current                  | Measured with HPD_SINK at $V_{IH-HPD}$ max and $V_{IL-HPD}$ min                                                                                     |     |     | 50       | $\mu A$ |
| $V_{OH-HPD\_SOURCE (INV)}$ | HPD_SOURCE output high level when FUNCTION3 = L | $V_{CC} = 3.3 V \pm 10\%$<br>Based on external pull-up resistor; output is open drain.                                                              |     |     |          |         |
| $V_{OL-HPD\_SOURCE}$       | HPD_SOURCE output low level when FUNCTION3 = H  | $V_{CC} = 3.3 V \pm 10\%$                                                                                                                           | 2.5 |     | $V_{CC}$ | V       |
| $V_{OH-HPD\_SOURCE (INV)}$ | HPD_SOURCE output high level when FUNCTION3 = L | $V_{CC} = 3.3 V \pm 10\%$<br>$I_{OL} = 1 mA$                                                                                                        | 0   |     | 0.2      | V       |
| $V_{OL-HPD\_SOURCE}$       | HPD_SOURCE output low level when FUNCTION3 = H  | $V_{CC} = 3.3 V \pm 10\%$                                                                                                                           | 0   |     | 0.2      | V       |
| $T_{HPD}$                  | HPD_SINK to HPD_SOURCE propagation delay        | Time from HPD_SINK changing state to HPD_SOURCE changing state. Includes HPD_SOURCE rise/fall time<br>$C_L = 10 pF$                                 |     |     | 200      | ns      |
| $T_{RF-HPD}$               | HPD_SOURCE rise/fall time                       | Time required to transition from $V_{OH-HPD\_SOURCE}$ to $V_{OL-HPD\_SOURCE}$ or from $V_{OL-HPD\_SOURCE}$ to $V_{OH-HPD\_SOURCE}$<br>$C_L = 10 pF$ | 1   |     | 20       | ns      |

## 5.4 DDC input and output characteristics

Table 11. SDA\_SOURCE, SCL\_SOURCE and SDA\_SINK, SCL\_SINK characteristics

| Symbol    | Parameter                                                | Comment                                                                                                                                                                                                             | Min | Typ | Max | Unit          |
|-----------|----------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $V_I$     | Input voltage on SDA_SINK, SCL_SINK pins                 | Voltage on the DDC pins on connector end                                                                                                                                                                            | 0   |     | 5.5 | V             |
| $I_{LKG}$ | Input leakage current on SDA_SINK, SCL_SINK pins         | $V_{CC} = 3.3\text{ V}$<br>$V_I = 0.1V_{DD}$ to $0.9V_{DD}$ to isolated DDC inputs<br>$V_{DD}$ = external pull-up resistor voltage on SDA_SINK and SCL_SINK inputs (maximum of 5.5 V)                               | -10 |     | 10  | $\mu\text{A}$ |
| $I_{OFF}$ | Power-down leakage current on SDA_SINK, SCL_SINK pins    | $V_{CC} = 0.0\text{ V}$<br>$V_I = 0.1V_{DD}$ to $0.9V_{DD}$ to DDC sink inputs<br>$V_{DD}$ = external pull-up resistor voltage on SDA_SINK and SCL_SINK inputs (maximum of 5.5 V)<br>SDA_SOURCE, SCL_SOURCE = 0.0 V | -10 |     | 10  | $\mu\text{A}$ |
| $C_{I/O}$ | Input/output capacitance (switch off)                    | $V_{I(pp)} = 1\text{ V}$ , 100 KHz<br>$V_{CC} = 3.3\text{ V}$ , $T = 25^\circ\text{C}$                                                                                                                              |     | 5   |     | pF            |
| $C_{I/O}$ | Input/output capacitance (switch on)                     | $V_{I(pp)} = 1\text{ V}$ , 100KHz<br>$V_{CC} = 3.3\text{ V}$ , $T = 25^\circ\text{C}$                                                                                                                               |     |     | 10  | pF            |
| $R_{ON}$  | Switch resistance                                        | $I_O = 3\text{ mA}$ , $V_O = 0.4\text{ V}$<br>$V_{CC} = 3.3\text{ V}$                                                                                                                                               |     | 27  | 40  | $\Omega$      |
| $T_{PD}$  | DDC_SINK to DDC_SOURCE propagation delay                 | Time from DDC_SINK changing state to DDC_SOURCE changing state while the pass gate is enabled.<br>$C_L = 10\text{ pF}$<br>$R_{PU} = 1.5\text{ K (min)}, 2.0\text{ K (max)}$                                         |     | 8   | 15  | ns            |
| $T_{SX}$  | Switch time from DDC_EN to the valid state on DDC_SOURCE | $C_L = 10\text{ pF}$<br>$R_{PU} = 1.5\text{ K (min)}, 2.0\text{ K (max)}$                                                                                                                                           |     | 8   | 15  | ns            |

## 5.5 OE\_ input characteristics

Table 12. OE\_N input characteristics

| Symbol         | Parameter             | Comment                                                         | Min | Typ | Max   | Unit    |
|----------------|-----------------------|-----------------------------------------------------------------|-----|-----|-------|---------|
| $V_{IH-OE\_N}$ | Input high level      |                                                                 | 2   |     | VCC33 | V       |
| $V_{IL-OE\_N}$ | Input low level       |                                                                 | 0   |     | 0.8   | V       |
| $I_{IN-OE\_N}$ | Input leakage current | Measured with OE_N at $V_{IH-OE\_N}$ max and $V_{IL-OE\_N}$ mix |     |     | 200   | $\mu A$ |

## 5.6 HPD input resistor

Table 13. HDP input resistor

| Symbol    | Parameter                         | Comment                                                  | Min   | Typ   | Max   | Unit     |
|-----------|-----------------------------------|----------------------------------------------------------|-------|-------|-------|----------|
| $R_{HPD}$ | HPD_SINK input pull-down resistor | Guarantees HPD_SINK is LOW when no display is plugged in | 130 K | 160 K | 190 K | $\Omega$ |

## 5.7 ESD performance

Table 14. ESD performance

| Symbol | Parameter                          | Test condition         | Min | Typ | Max | Unit |
|--------|------------------------------------|------------------------|-----|-----|-----|------|
| ESD    | MIL STD 883 method 3015 (all pins) | Human Body Model (HBM) | -6  |     | +6  | kV   |

## 6 Application information

### 6.1 Power supply sequencing

Proper power-supply sequencing is advised for all CMOS devices. It is recommended to always apply  $V_{CC}$  before applying any signals to the input/output or control pins.

### 6.2 Supply bypassing

Bypass each of the  $V_{CC}$  pins with 0.1  $\mu$ F and 1nF capacitors in parallel as close to the device as possible, with the smaller-valued capacitor as close to the  $V_{CC}$  pin of the device as possible.

### 6.3 Differential traces

The high-speed inputs and TMDS outputs are the most critical parts for the device. There are several considerations to minimize discontinuities on these transmission lines between the connectors and the device.

- (a) Maintain 100  $\Omega$  differential transmission line impedance into and out of the device.
- (b) Keep an uninterrupted ground plane below the high-speed I/Os.
- (c) Keep the ground-path vias to the device as close as possible to allow the shortest return current path.
- (d) Layout of the TMDS differential outputs should be with the shortest stubs from the connectors.

Output trace characteristics affect the performance of the STHDLS101T. Use controlled impedance traces to match trace impedance to both the transmission medium impedance and termination resistor. Run the differential traces close together to minimize the effects of the noise. Reduce skew by matching the electrical length of the traces. Avoid discontinuities in the differential trace layout. Avoid 90 degree turns and minimize the number of vias to further prevent impedance discontinuities.

## 7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

Obsolete Product(s) - Obsolete Product(s)

SEATING PLANE

C

A3

A1

A2

A

D

e

37

48

PIN #1 ID  
R=0.20

36

1

e

E

12

L

13

L

24

25

b

D2

E2

b

+

Obsolete Product(s)

BOTTOM VIEW

**Table 15. QFN-48 (7 x 7 mm) package mechanical data**

| Symbol | Min  | Typ  | Max  | Min                        | Typ  | Max  |
|--------|------|------|------|----------------------------|------|------|
| A      | 0.80 | 0.90 | 1.00 | 0.80                       | 0.85 | 1.00 |
| A1     |      | 0.02 | 0.05 |                            | 0.01 | 0.05 |
| A2     |      | 0.65 | 1.00 |                            | 0.65 |      |
| A3     |      | 0.25 |      |                            | 0.20 |      |
| b      | 0.18 | 0.23 | 0.30 | 0.18                       | 0.23 | 0.30 |
| D      | 6.85 | 7.00 | 7.15 | 6.90                       | 7.00 | 7.10 |
| D2     | 2.25 | 4.70 | 5.25 | SEE EXPOSED PAD VARIATIONS |      |      |
| E      | 6.85 | 7.00 | 7.15 | 6.90                       | 7.00 | 7.10 |
| E2     | 2.25 | 4.70 | 5.25 | SEE EXPOSED PAD VARIATIONS |      |      |
| e      | 0.45 | 0.50 | 0.55 | 0.45                       | 0.50 | 0.55 |
| L      | 0.30 | 0.40 | 0.50 | 0.30                       | 0.40 | 0.50 |
| ddd    |      |      | 0.08 |                            |      | 0.08 |

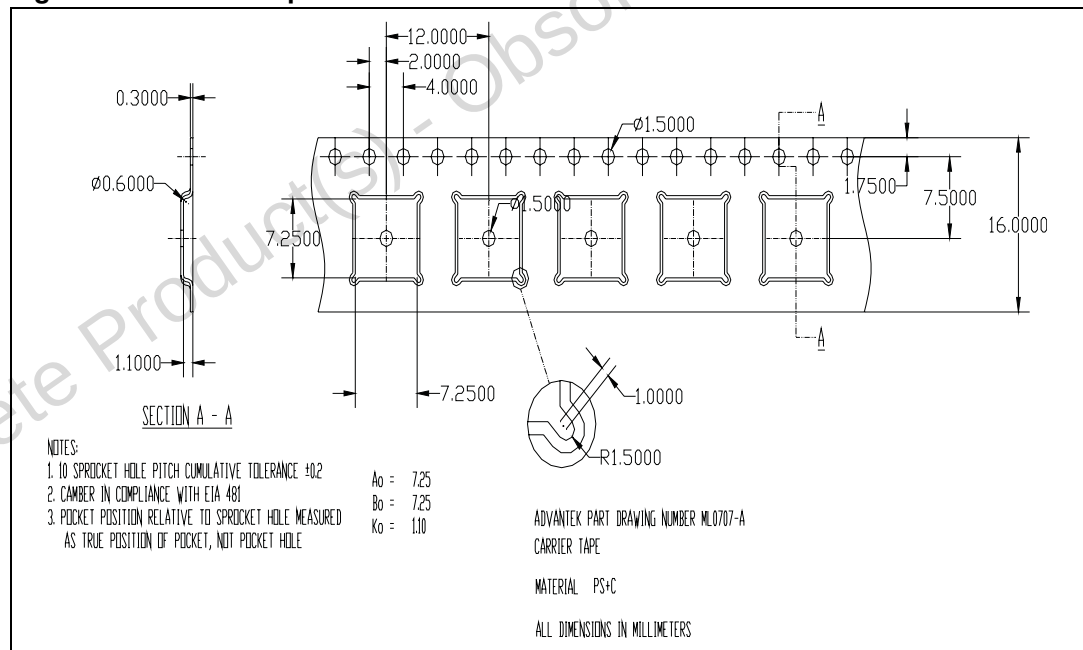
**Figure 7. QFN-48 tape and reel information**

Figure 8. Reel information

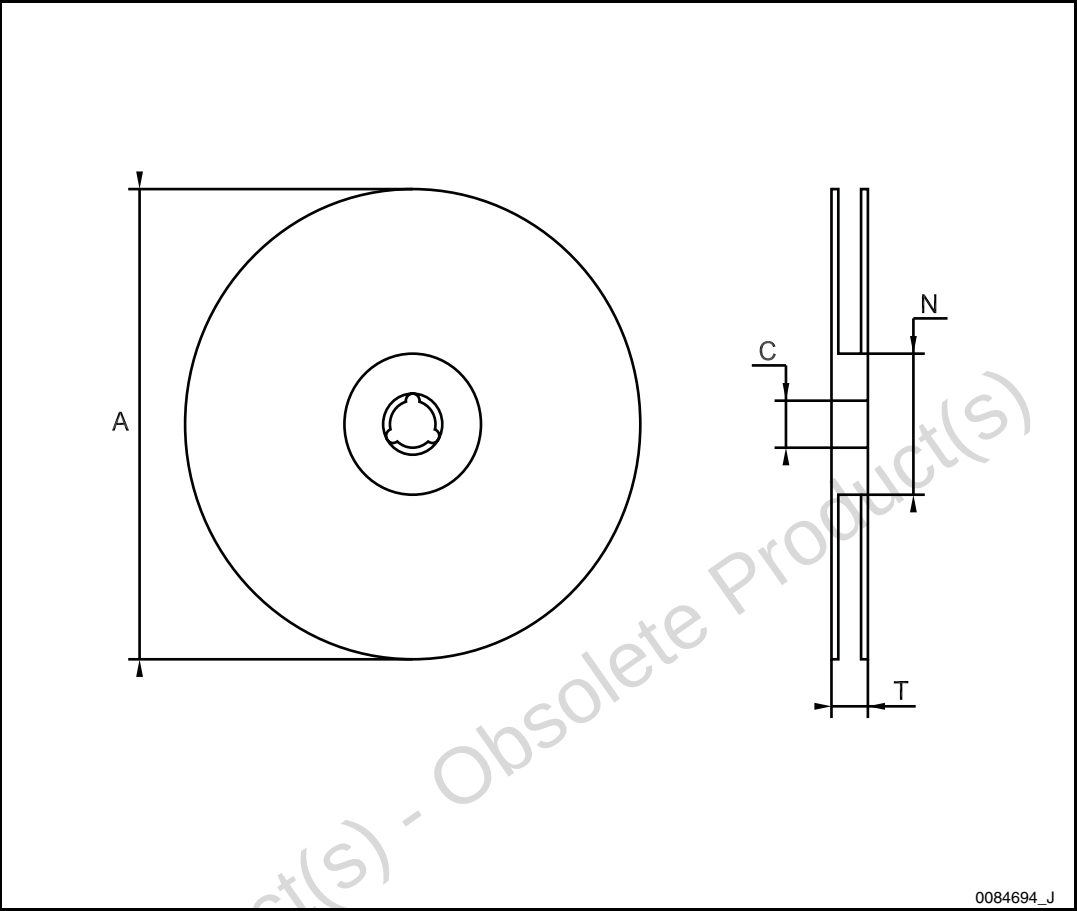


Table 16. Reel mechanical data (dimensions in mm)

| A     | C        | N   | T    |
|-------|----------|-----|------|
| 330.2 | 13 ±0.25 | 100 | 16.4 |

## 8 Revision history

**Table 17. Document revision history**

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                                                          |
|-------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 30-Jun-2008 | 1        | Initial release.                                                                                                                                                                                                                                                                                                                                 |
| 24-Sep-2008 | 2        | Document status promoted from preliminary data to datasheet.<br>Modified: features section, <a href="#">Table 2: Pin description on page 8</a> and <a href="#">Section 4: Functional description</a> .                                                                                                                                           |
| 01-Dec-2008 | 3        | Updated: Features section and <a href="#">Chapter 5: Maximum ratings</a><br>Added: <a href="#">Figure 3: Cable adapter on page 5</a> , <a href="#">Figure 4: DP to HDMI/DVI cable adapter on page 6</a> , <a href="#">Figure 8: Reel information on page 24</a> and <a href="#">Table 16: Reel mechanical data (dimensions in mm) on page 24</a> |

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